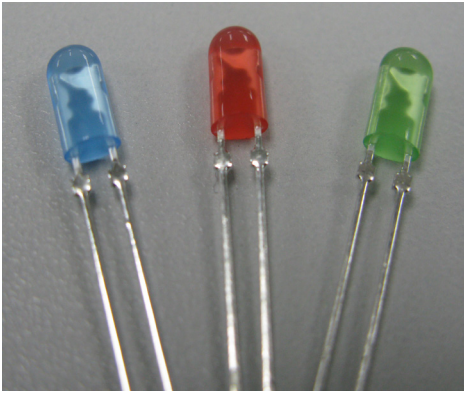


Screen Master® 4-mm Oval LEDs: C4SMX-RGY/GGY/BGY



PRODUCT DESCRIPTION

These oval LEDs are specifically designed for full-color video screens, digital billboards and passenger-information signs. The oval-shaped radiation pattern and high luminous intensity ensure that these devices are excellent for bright sunlight or low power consumption outdoor applications.

These lamps are made with an advanced optical-grade epoxy that offers superior high-temperature and high-moisture-resistance performance in outdoor signal and sign applications. The encapsulation resin contains anti-UV material in order to reduce the effects of long-term exposure to direct sunlight.

FEATURES

- Size (mm): 4
- Color and Typical Dominant Wavelength:
Red (621nm)
Green (527nm)
Blue (470nm)
- Luminous Intensity (mcd)
C4SMX-RGY: (1205-1824)@15mA
C4SMX-GGY: (2564-3885)@15mA
C4SMX-BGY: (510-770)@10mA
- Lead - Free
- RoHS Compliant

APPLICATIONS

- Electronic Signs & Signals (ESS)
- Full Color Video Screen
- Digital Billboards
- Motorway Signs
- Variable Message Sign (VMS)
- Advertising Signs
- Petrol Signs

ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$)

Items	Symbol	Absolute Maximum Rating		Unit
		Red	Blue and Green	
Forward Current	I_F	50 ^{Note1}	35	mA
Peak Forward Current ^{Note2}	I_{FP}	200	100	mA
Reverse Voltage	V_R	5	5	V
Power Dissipation	P_D	130	140	mW
Operation Temperature	T_{opr}	-40 ~ +95		$^\circ\text{C}$
Storage Temperature	T_{stg}	-40 ~ +100		$^\circ\text{C}$
Lead Soldering Temperature	T_{sol}	Max. 260 $^\circ\text{C}$ for 3 sec. max. (3 mm from the base of the epoxy bulb)		
Electrostatic Discharge Classification (MIL-STD-883E)	ESD	Class 2		

Note:

- For long term performance the drive currents between 10mA and 30mA are recommended. Please contact Cree LED sales representative for more information on recommended drive conditions.
- Pulse width ≤ 0.1 msec, duty $\leq 1/10$.

TYPICAL ELECTRICAL & OPTICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$)

Characteristics	Color	Symbol	Condition	Unit	Minimum	Typical	Maximum
Forward Voltage	Red	V_F	$I_F = 15$ mA	V		2.0	2.6
	Green	V_F	$I_F = 15$ mA	V		2.9	3.5
	Blue	V_F	$I_F = 10$ mA	V		2.9	3.5
Reverse Current	Red	I_R	$V_R = 5$ V	μA			100
	Blue/Green	I_R	$V_R = 5$ V	μA			100
Dominant Wavelength	Red	λ_D	$I_F = 15$ mA	nm	619	621	624
	Green	λ_D	$I_F = 15$ mA	nm	520	527	530
	Blue	λ_D	$I_F = 10$ mA	nm	465	470	475
Luminous Intensity	Red	I_V	$I_F = 15$ mA	mcd	1205	1500	
	Green	I_V	$I_F = 15$ mA	mcd	2564	3200	
	Blue	I_V	$I_F = 10$ mA	mcd	510	630	

* Continuous reverse voltage can cause LED damage.

INTENSITY BIN LIMIT

Red (15 mA) - C4SMX-RGY			Green (15 mA) - C4SMX-GGY			Blue (10 mA) - C4SMX-BGY		
Bin Code	Min.(mcd)	Max.(mcd)	Bin Code	Min.(mcd)	Max.(mcd)	Bin Code	Min.(mcd)	Max.(mcd)
T2	1205	1310	V3	2564	2781	Q4	510	550
T3	1310	1415	V4	2781	3000	R1	550	605
T4	1415	1520	W1	3000	3295	R2	605	660
U1	1520	1672	W2	3295	3590	R3	660	715
U2	1672	1824	W3	3590	3885	R4	715	770

* Tolerance of measurement of luminous intensity is $\pm 15\%$

COLOR BIN LIMIT

Red (15 mA) - C4SMX-RGY			Green (15 mA) - C4SMX-GGY			Blue (10 mA) - C4SMX-BGY		
Bin Code	Min.(nm)	Max.(nm)	Bin Code	Min.(nm)	Max.(nm)	Bin Code	Min.(nm)	Max.(nm)
RB	619	624	G7	520	525	B4	465	470
			G23	522.5	527.5	B45	467.5	472.5
			G8	525	530	B5	470	475
			G45	527.5	532.5			
			G9	530	535			

* Tolerance of measurement of dominant wavelength is ± 1 nm.

ORDER CODE TABLE

C4SMX-RGY

Color	Kit Number	Luminous Intensity (mcd)		Dominant Wavelength				Package
		Min.	Max.	Color Bin	Min. (nm)	Color Bin	Max. (nm)	
Red	C4SMX-RGY-CT2U2BB1	1205	1824	RB	619	RB	624	Bulk
Red	C4SMX-RGY-CT22QBB1	Any 2 consecutive sub-bins: T2(1205) - U2(1824)		RB	619	RB	624	Bulk
Red	C4SMX-RGY-CT2U2BB2	1205	1824	RB	619	RB	624	Ammo
Red	C4SMX-RGY-CT22QBB2	Any 2 consecutive sub-bins: T2(1205) - U2(1824)		RB	619	RB	624	Ammo

C4SMX-GGY

Color	Kit Number	Luminous Intensity (mcd)		Dominant Wavelength				Package
		Min.	Max.	Color Bin	Min. (nm)	Color Bin	Max. (nm)	
Green	C4SMX-GGY-CV3W3791	2564	3885	G7	520	G9	530	Bulk
Green	C4SMX-GGY-CV32Q7C1	Any 2 consecutive sub-bins: V3(2564) - W3(3885)		Any 1 color bin from G7 (520) to G9 (530)				Bulk
Green	C4SMX-GGY-CV3W3792	2564	3885	G7	520	G9	530	Ammo
Green	C4SMX-GGY-CV32Q7C2	Any 2 consecutive sub-bins: V3(2564) - W3(3885)		Any 1 color bin from G7 (520) to G9 (530)				Ammo

C4SMX-BGY

Color	Kit Number	Luminous Intensity (mcd)		Dominant Wavelength				Package
		Min.	Max.	Color Bin	Min. (nm)	Color Bin	Max. (nm)	
Blue	C4SMX-BGY-CQ4R4451	510	770	B4	465	B5	475	Bulk
Blue	C4SMX-BGY-CQ42Q4S1	Any 2 consecutive sub-bins: Q4(510) - R4(770)		Any 1 color bin from B4 (465) to B5 (475)				Bulk
Blue	C4SMX-BGY-CQ4R4452	510	770	B4	465	B5	475	Ammo
Blue	C4SMX-BGY-CQ42Q4S2	Any 2 consecutive sub-bins: Q4(510) - R4(770)		Any 1 color bin from B4 (465) to B5 (475)				Ammo

Notes:

- The above kit numbers represent order codes that include multiple intensity-bin and color-bin codes. Only one intensity-sub-bin code and one color-bin code will be shipped on each reel. Selected single intensity-bin, single color-bin codes will be orderable in certain quantities. For example, any four consecutive sub-bins from V1 to W2 mean only one intensity bin with four sub-bins of the following brightness ranges (V1-V4, V2-W1, V3-W2) will be shipped by Cree LED. For example, any one-color bin from G7 to Ga means only one color bin (G7 or G23 or G8 or G45 or G9 or G67 or Ga) will be shipped by Cree LED.
- Please refer to the [HB LED Lamp Reliability Test Standards](#) document for reliability test conditions.
- Please refer to the [HB LED Lamp Soldering & Handling](#) document for information about how to use this LED product safely.

GRAPHS

The data below are collected from statistical figures that do not necessarily correspond to the actual parameters of each single LED. Hence, these data will be changed without further notice.

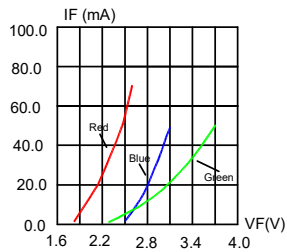


FIG.1 FORWARD CURRENT VS. FORWARD VOLTAGE.

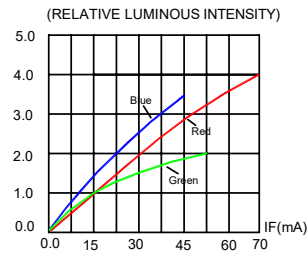


FIG.2 RELATIVE LUMINOUS INTENSITY VS. FORWARD CURRENT

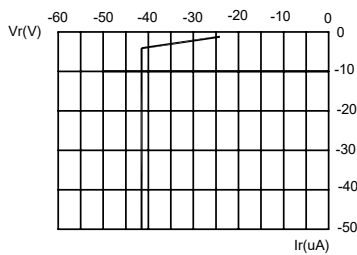


FIG.3a RED REVERSE CURRENT VS. REVERSE VOLTAGE.

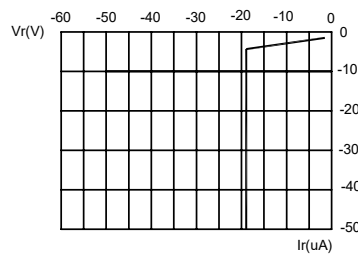


FIG.3b BLUE & GREEN REVERSE CURRENT VS. REVERSE VOLTAGE.

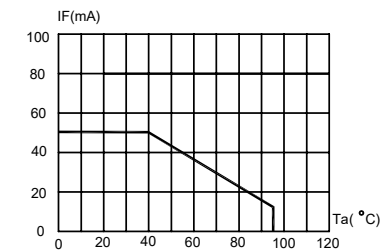


FIG.4a RED MAXIMUM FORWARD DC CURRENT VS AMBIENT TEMPERATURE ($T_{jmax}=105^{\circ}C$)

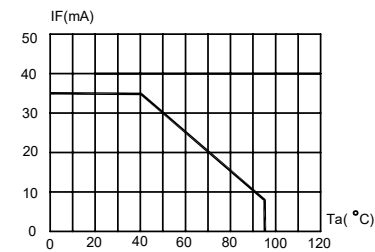


FIG.4b BLUE & GREEN MAXIMUM FORWARD DC CURRENT VS AMBIENT TEMPERATURE ($T_{jmax}=105^{\circ}C$)

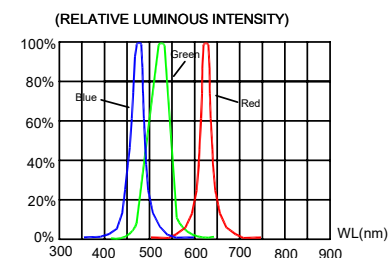


FIG.5 RELATIVE LUMINOUS INTENSITY VS. WAVELENGTH.

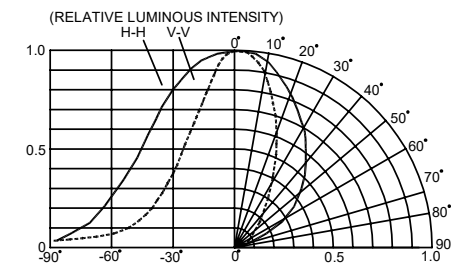


FIG.6a BLUE&GREEN FAR FIELD PATTERN

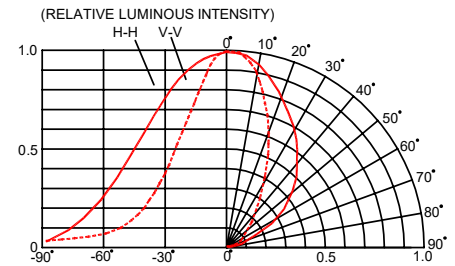


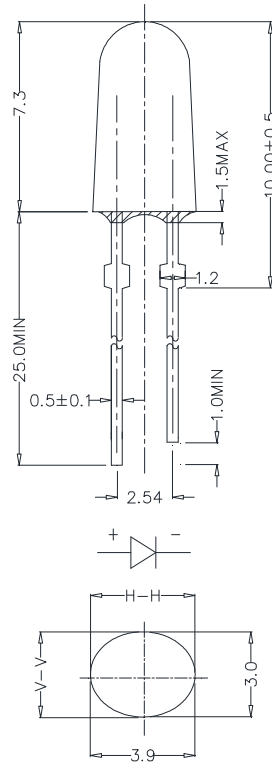
FIG.6b RED FAR FIELD PATTERN

MECHANICAL DIMENSIONS

All dimensions are in mm. Tolerance is ± 0.25 mm unless otherwise noted.

An epoxy meniscus may extend about 1.5 mm down the leads.

Burr around bottom of epoxy may be 0.5 mm max.



NOTES

Lead Frame Materials

Ag-plated and Lead-free Solder-plated iron.

RoHS Compliance

The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2011/65/EC (RoHS2), as implemented January 2, 2013. RoHS Declarations for this product can be obtained from your Cree LED representative or from the [Product Ecology](#) section of the Cree LED website.

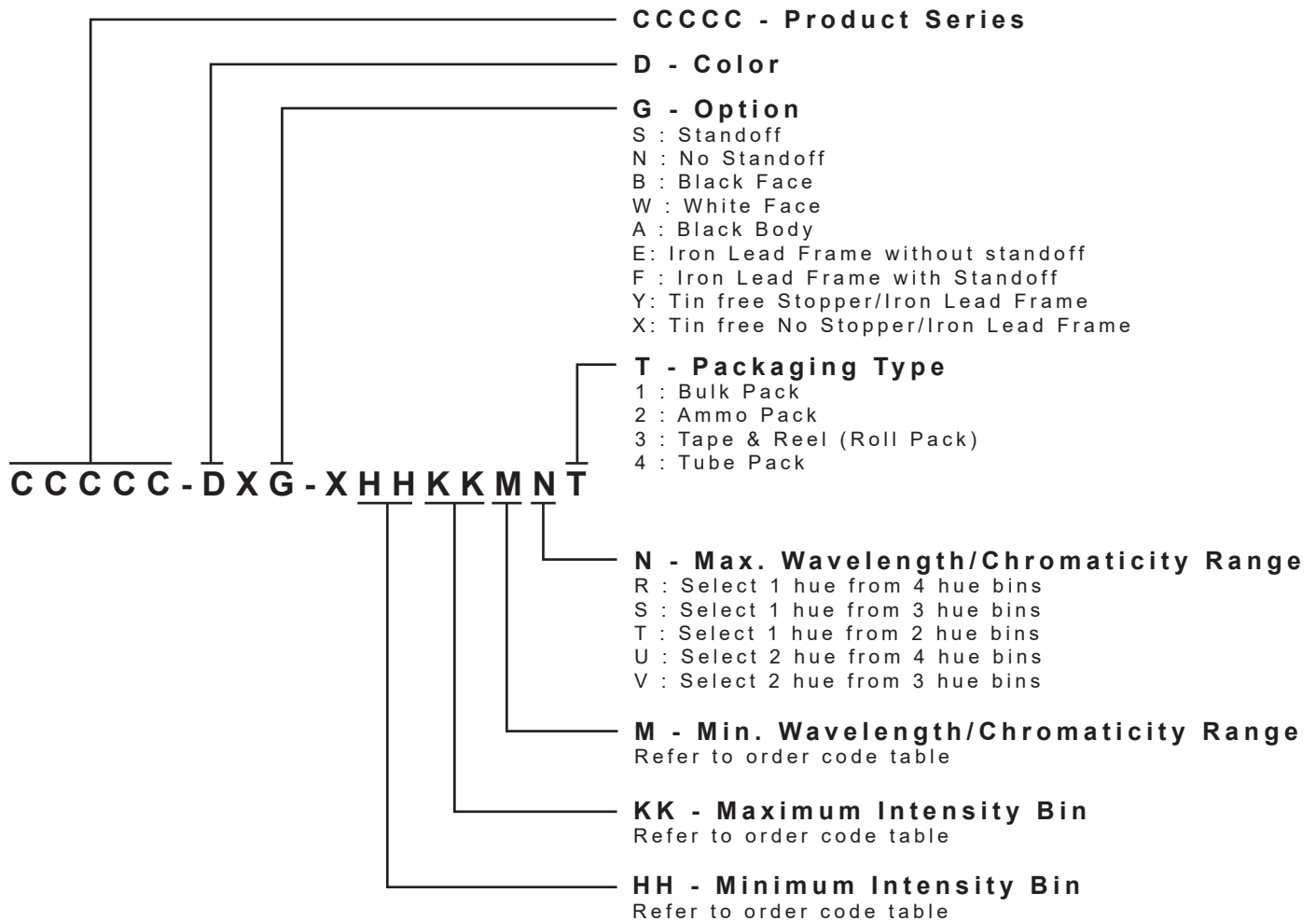
Vision Advisory

WARNING: Do not look at an exposed lamp in operation. Eye injury can result.

KIT NUMBER SYSTEM

Cree LED lamps are tested and sorted into performance bins. A bin is specified by ranges of color, forward voltage, and brightness. Sorted LEDs are packaged for shipping in various convenient options.

Cree LEDs are sold by order codes in combinations of bins called kits. Order codes are configured in the following manner:



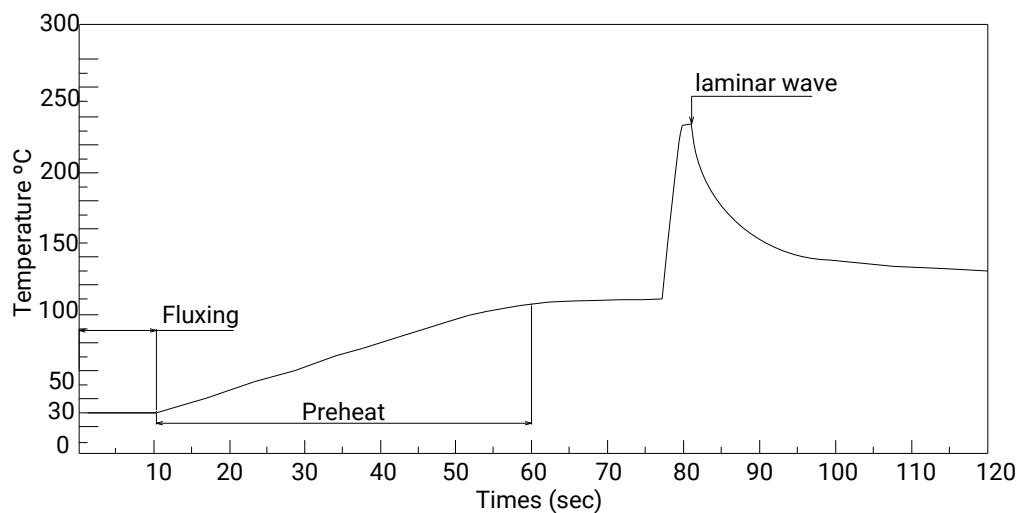
* Please contact our sales representative for ordering information.

SOLDERING GUIDELINES

The LED soldering specification is shown below (suitable for both leaded solder & lead-free solder):

Manual Soldering		Solder Dipping	
Soldering iron	35 W max	Preheat	110 °C max
Temperature	300 °C max	Preheat time	60 seconds max
Soldering time	3 seconds max	Solder-bath temperature	260 °C Max
Position	Not less than 3 mm from the base of the package.	Dipping time	5 seconds max
		Position	Not less than 3 mm from the base of the package.

- Manual soldering onto the PCB is not recommended because soldering time is uncontrollable.
- The recommended wave soldering is as below:

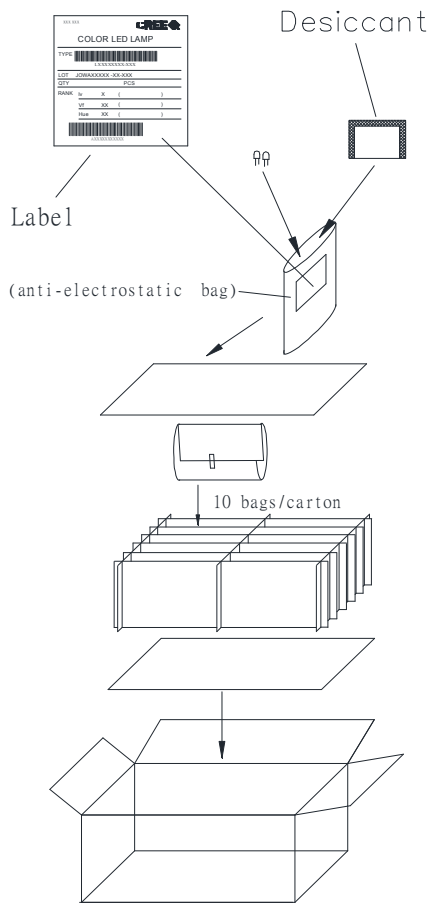


- Do not apply any stress to the LED package, particularly when heated.
- Only bottom preheat is suggested & should not preheat on top in order to reduce thermal stress experienced by the LEDs.
- The LEDs must not be re used once they have been extracted from PCB.
- After soldering the LEDs, the package should be protected from mechanical shock or vibration until the LEDs have reached 40 °C or below.
- Precautions must be taken as mechanical stress on the LEDs may be caused by PCB warpage or from the clinching and cutting of the LED leads.
- When it is necessary to clam the LEDs during soldering, it is important to ensure no mechanical stress is exerted on the LEDs.
- Cut the LED lead at normal room temperature. Lead cutting at high temperature may cause failure of the LEDs.
- Please refer to the [HB LED Lamp Soldering & Handling](#) document for information about how to use this LED product safely.

PACKAGING

- The LEDs are packed in cardboard boxes after packaging in normal or anti-electrostatic bags.
- Cardboard boxes will be used to protect the LEDs from mechanical shock during transportation.
- The boxes are not water resistant, and they must be kept away from water and moisture.
- Max 1000 pcs per bulk and Max 3000 pcs per ammo.

Bulk Pack Packaging Type:



Ammo Pack Packaging Type:

